ABBOGIATION CONNECTING ELECTRONICS (MOUSTRIES*) international and Pan-American	kburn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declara he declaration	ion of the s encompasse	ubstances s all lowe	within the manuf er level materials f	acturer liste for which the	d item. No e manufact	ote: if the in turer has e	tem is an assen engineering res	nbly with lower ponsibility.
	P1.1 IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distrib			*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					als and Mfg Information			
Supplier Information													
Company name* Company unique ID				Unique ID Authority					Resp	Response Date*			
nsemi										2025-06-06			
Contact Name	Title - Contact			]	Phone - Contact*				Emai	Email - Contact*			
Product-Env-Stewards	nv-Stewards Product Enviro Compliance			NA					Prod	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative				]	Phone - Representative*					Email - Representative*			
Product-Env-Stewards Product Enviro Compliance				NA					Prod	Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr It	em Number	Mfr Item Name			Effective Dat	e Version	]	Manufacturing Site		Weight*	* U	UOM	Unit Type
NLV <sup>V</sup> G	HC1GT14DFT2	IC1GT14DFT2 LOG CMOS SCHMITT T			2025-06-06		•	CN1		6.2	r	mg	Each
Manufacturing Proccess Information													
Terminal Plating / Grid Array Material	Terminal Base Alloy J-STD-		J-STD-020 MSL	Rating	Peak Pro	Peak Process Body Temperat		ure Max Time at Peak Tempe		rature N	umber of I	Reflow Cycles	
Matte Tin (Sn) - annealed CU Alloy 1		1		260		С	30	sec	conds 3				
Comments													
evel 1 - maximum time at peak temperature during	soldering is 10-3	0 seconds											
for more information regarding material composition	n please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless	otherwise noted).				-	_		-
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.19	mg	Supplier	Silicon (Si)	7440-21-3		0.19	mg
Lead Frame 2	2.04	mg	В	Nickel (Ni)	7440-02-0		0.7813	mg
			Supplier	Iron (Fe)	7439-89-6		1.0792	mg
			Supplier	Copper (Cu)	7440-50-8		0.1795	mg
Mold Compound-Black	3.9	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.39	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0195	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.5655	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		2.535	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.39	mg
Plating	0.05	mg	Supplier	Tin (Sn)	7440-31-5		0.05	mg
Wire Bond - Au	0.02	mg	Supplier	Gold (Au)	7440-57-5		0.02	mg